SDLS026

SN5401, SN54LS01, SN7401, SN74LS01 QUADRUPLE 2-INPUT POSITIVE-NAND GATES WITH OPEN-COLLECTOR OUTPUTS

APRIL 1985 - REVISED MARCH 1988

- Package Options Include Plastic "Small Outline" Packages, Ceramic Chip Carriers and Flat Packages, and Plastic and Ceramic DIPs
- Dependable Texas Instruments Quality and Reliability

description

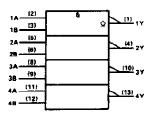
These devices contain four independent 2-input NAND gates. The open-collector outputs require pull-up resistors to perform correctly. They may be connected to other open-collector outputs to implement active-low wired-OR or active-high wired-AND functions. Open-collector devices are often used to generate higher VOH levels.

The SN5401 and SN54LS01 are characterized for operation over the full military temperature range of -55°C to 125°C. The SN7401 and SN74LS01 are characterized for operation from 0°C to 70°C.

FUNCTION TABLE (each gate)

INP	UTS	OUTPUT
A	В	Y
н	н	L
L	Х	н
×	L	н

logic symbol[†]



[†]This symbol is in accordance with ANSI/IEEE Std. 91-1984 and IEC Publication 617-12.

Pin numbers shown are for D, J, N, and W packages.

APRIL 1985 - REVISE
SN5401 J PACKAGE SN54LS01 J OR W PACKAGE SN7401 N PACKAGE SN74LS01 D OR N PACKAGE (TOP VIEW)
$\begin{array}{c ccccccccccccccccccccccccccccccccccc$
SN5401 W PACKAGE (TOP VIEW)
$ \begin{array}{c ccccccccccccccccccccccccccccccccccc$
SN54LS01 FK PACKAGE (TOP VIEW)
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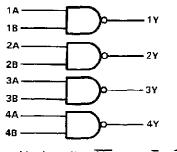
NC - No internal connection

PRODUCTION DATA documents contain information current as of publication date. Products conform to specifications per the terms of Texas instruments standard warranty. Production processing does not necessarily include testing of all parameters.



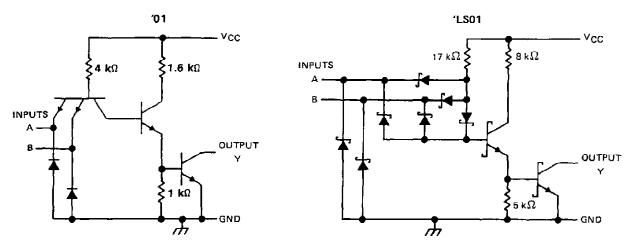
SN5401, SN54LS01. SN7401, SN74LS01 QUADRUPLE 2-INPUT POSITIVE-NAND GATES WITH OPEN-COLLECTOR OUTPUTS

logic diagram (positive logic)



positive logic; Y = $\overline{A \cdot B}$ or Y = $\overline{A} + \overline{B}$

schematics (each gate)



Resistor values shown are nominal.

absolute maximum ratings over operating free-air temperature range (unless otherwise noted)

Supply voltage, VCC (see Note 1): '0	D1, ′LSO1	7 V
Off-state output voltage		7 V
	SN54'	
	SN74′	0°C to 70°C
Storage temperature range		5°C to 150°C

NOTE 1: Voltage values are with respect to network ground terminals.



SN5401, SN7401 QUADRUPLE 2 INPUT POSITIVE NAND GATES WITH OPEN-COLLECTOR OUTPUTS

recommended operating conditions

			SN5401			SN7401			
		MIN	NOM	ΜΑΧ	MIN	NOM	мах	UNIT	
Vcc	Supply voltage	4.5	5	5.5	4.75	5	5.25	V	
VIH	High-level input voltage	2			2			v	
ViL	Low-level input voltage			0.8			0.8	V	
∨он	High-level output voltage			5.5			5,5	v	
IOL	Low-level output current			16			16	mΑ	
Тд	Operating free-air temperature	- 55		125	0		70	°C	

electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

PARAMETER	TEST CONDITIONS [†]	SN5401	SN7401	
	TEST CONDITIONS.	MIN TYP [‡] MAX	MIN TYP [‡] MAX	UNIT
Vik	$V_{CC} = MIN, I = -12 mA$	- 1.5	- 1.5	v
Іон	$V_{CC} = MIN, V_{IL} = 0.8 V, V_{OH} = 5.5 V$		0.25	^
	VCC = MIN, VIL = 0.7 V, VOH = 5.5 V	0.25		mΑ
VOL	V _{CC} = MIN, V _{IH} = 2 V, I _{OL} = 16 mA	0.2 0.4	0.2 0.4	V
4	VCC = MAX, VI = 5.5 V	1	1	mΑ
ΪН	$V_{CC} = MAX, V_{I} = 2.4 V$	40	40	μA
ηĽ	$V_{CC} = MAX, V_I = 0.4 V$	-1.6	- 1.6	mА
ССН	$V_{CC} = MAX, \forall_{ } = 0$	4 8	4 8	mΑ
ICCL	$V_{CC} = MAX, V_{\parallel} = 4.5 V$	12 22	12 22	mA

[†]For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions. [‡]All typical values are at $V_{CC} = 5 V$, $T_A = 25 °C$.

switching characteristics, $V_{CC} = 5 V$, $T_A = 25^{\circ}C$ (see note 2)

PARAMETER	FROM (INPUT)	TO (OUTPUT)	TEST CON	MIN	TYP	МАХ	UNIT	
TPLH	A or B	v	RL=4kΩ,	CL = 15 pF		35	55	ns
^t PHL	7015		R _L = 400 Ω,	CL = 15 pF		8	15	ns

NOTE 2: Load circuits and voltage waveforms are shown in Section 1.

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SN54LS01, SN74LS01 QUADRUPLE 2-INPUT POSITIVE-NAND GATES WITH OPEN-COLLECTOR OUTPUTS

recommended operating conditions

		SN54LS01			SN74LS01			
	MIN	NOM	MAX	MIN	NOM	МАХ		
V _{CC} Supply voltage	4,5	5	5.5	4.75	5	5.25	V	
VIH High-level input voltage	2			2			V	
VIL Low-level input voltage			0.7		····	0.8	v	
VOH High-level output voltage			5.5			5.5	V	
IOL Low-level output current			4			8	mА	
T _A Operating free-air temperature	- 55		125	0		70	°c	

electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

	ł	TEST CONDI		SN54LS	01					
PARAMETER		TEST CONDI	TIONS	MIN	TYP‡	МАХ	MIN	TYP‡	МАХ	
VIK	V _{CC} = MIN,	lj = ~ 18 mA				- 1.5			- 1.5	V
юн	V _{CC} = MIN,	V _{IL} = MAX,	V _{OH} = 5.5 V			0.1			0.1	mΑ
14	Vcc = MIN,	V _{IH} = 2 V,	IQL = 4 mA		0.25	0.4		0.25	0.4	v
V _{OL}	Vcc = MIN,	V _{IH} ≈ 2 V,	IOL = 8 mA					0.35	0.5	1 ×
4	V _{CC} = MAX,	V ₁ = 7 V				0.1	1		0.1	mA
Чн	V _{CC} = MAX,	V ₁ = 2.7 V				20	1		20	μA
ηΓ	V _{CC} = MAX,	V ₁ = 0.4 V				- 0.4			- 0.4	mA
ICCH	VCC = MAX,	VI = 0			0.8	1.6		0.8	1.6	mΑ
ICCL	V _{CC} ≠ MAX,	V ₁ = 4.5 V			2.4	4.4		2.4	4.4	mA

 \uparrow For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions. \ddagger All typical values are at V_{CC} = 5 V, T_A = 25°C.

switching characteristics, V_{CC} = 5 V, T_A = 25° C (see note 2)

PARAMETER	FROM (INPUT)	TO {OUTPUT}	TEST CONDITIONS	MIN	TYP	МАХ	UNIT
tPLH	A or B	Y	RL=2 kΩ, CL=15 pF		17	32	nş
[‡] PHL					15	28	ns

NOTE 2: Load circuits and voltage waveforms are shown in Section 1.





PACKAGING INFORMATION

Orderable Device	Status (1)	Package Type	Package Drawing	Pins	Package Qty	Eco Plan (2)	Lead finish/ Ball material (6)	MSL Peak Temp (3)	Op Temp (°C)	Device Marking (4/5)	Samples
SN5401J	ACTIVE	CDIP	J	14	25	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	SN5401J	Samples
SN54LS01J	ACTIVE	CDIP	J	14	25	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	SN54LS01J	Samples
SN54LS01J	ACTIVE	CDIP	J	14	25	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	SN54LS01J	Samples
SNJ5401J	ACTIVE	CDIP	J	14	25	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	SNJ5401J	Samples
SNJ5401J	ACTIVE	CDIP	J	14	25	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	SNJ5401J	Samples
SNJ5401W	ACTIVE	CFP	W	14	25	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	SNJ5401W	Samples
SNJ5401W	ACTIVE	CFP	W	14	25	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	SNJ5401W	Samples
SNJ54LS01J	ACTIVE	CDIP	J	14	25	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	SNJ54LS01J	Samples
SNJ54LS01J	ACTIVE	CDIP	J	14	25	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	SNJ54LS01J	Samples
SNJ54LS01W	ACTIVE	CFP	W	14	25	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	SNJ54LS01W	Samples
SNJ54LS01W	ACTIVE	CFP	W	14	25	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	SNJ54LS01W	Samples

⁽¹⁾ The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

OBSOLETE: TI has discontinued the production of the device.

⁽²⁾ RoHS: TI defines "RoHS" to mean semiconductor products that are compliant with the current EU RoHS requirements for all 10 RoHS substances, including the requirement that RoHS substance do not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, "RoHS" products are suitable for use in specified lead-free processes. TI may reference these types of products as "Pb-Free".

RoHS Exempt: TI defines "RoHS Exempt" to mean products that contain lead but are compliant with EU RoHS pursuant to a specific EU RoHS exemption.



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PACKAGE OPTION ADDENDUM

Green: TI defines "Green" to mean the content of Chlorine (CI) and Bromine (Br) based flame retardants meet JS709B low halogen requirements of <=1000ppm threshold. Antimony trioxide based flame retardants must also meet the <=1000ppm threshold requirement.

(3) MSL, Peak Temp. - The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

⁽⁴⁾ There may be additional marking, which relates to the logo, the lot trace code information, or the environmental category on the device.

⁽⁵⁾ Multiple Device Markings will be inside parentheses. Only one Device Marking contained in parentheses and separated by a "~" will appear on a device. If a line is indented then it is a continuation of the previous line and the two combined represent the entire Device Marking for that device.

⁽⁶⁾ Lead finish/Ball material - Orderable Devices may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead finish/Ball material values may wrap to two lines if the finish value exceeds the maximum column width.

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TEXAS INSTRUMENTS

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TUBE



- B - Alignment groove width

*All dimensions are nominal

Device	Package Name	Package Type	Pins	SPQ	L (mm)	W (mm)	Τ (μm)	B (mm)
SNJ5401W	W	CFP	14	25	506.98	26.16	6220	NA
SNJ54LS01W	W	CFP	14	25	506.98	26.16	6220	NA

W (R-GDFP-F14)

CERAMIC DUAL FLATPACK



- A. All linear dimensions are in inches (millimeters).
 - B. This drawing is subject to change without notice.
 - C. This package can be hermetically sealed with a ceramic lid using glass frit.
 - D. Index point is provided on cap for terminal identification only.
 - E. Falls within MIL STD 1835 GDFP1-F14



GENERIC PACKAGE VIEW

CDIP - 5.08 mm max height

CERAMIC DUAL IN LINE PACKAGE



Images above are just a representation of the package family, actual package may vary. Refer to the product data sheet for package details.



J0014A



PACKAGE OUTLINE

CDIP - 5.08 mm max height

CERAMIC DUAL IN LINE PACKAGE



NOTES:

- 1. All controlling linear dimensions are in inches. Dimensions in brackets are in millimeters. Any dimension in brackets or parenthesis are for reference only. Dimensioning and tolerancing per ASME Y14.5M.
- 2. This drawing is subject to change without notice.
- 3. This package is hermitically sealed with a ceramic lid using glass frit.
- Index point is provided on cap for terminal identification only and on press ceramic glass frit seal only.
 Falls within MIL-STD-1835 and GDIP1-T14.



J0014A

EXAMPLE BOARD LAYOUT

CDIP - 5.08 mm max height

CERAMIC DUAL IN LINE PACKAGE





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